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Design, Fabrication and Demonstration of a 1×20 Multimode Interference Splitter for Parallel Biosensing Applications

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Abstract. This paper presents the experimental achievement of a silicon-on-insulator 1×20 MMI splitter and simulation evaluations of the TE-like and TM-like mode MMI splitters for parallel biosensing applications. Device fabrication technology and optical characterisation results are provided.

1. Introduction

In 1973, Olof Brynghal used Fresnel image planes and a pinhole array to demonstrate the formation of multiple images of an object based on self-imaging techniques [1]. In 1975 R. Ulrich reviewed this phenomenon on multimode planar slab waveguides [2, 3] which was explained in more detail by Heaton et al. [4] in 1992. In 1995 Soldano and Pennings [5] stated the principle as “*Self-imaging is a property of multimode waveguides by which an input field profile is reproduced in single or multiple images at periodic intervals along the propagation direction of the guide*”.

Multimode Interference (MMI) devices are based on this self-imaging principle where the input image is reproduced into multiple images at the output with high uniformity [5]. Compared to Y-branches, MMI splitters can be made very compact and sharply increase tolerance to fabrication errors, as sharp edges near the branching points are avoided. MMI devices also have wide optical bandwidths, low cross talk and polarisation independence and are widely used in integrated optics as power splitters [6, 7], modulators [8], multiplexers [9], switches [10] and Mach-Zehnder interferometers [7].

$1 \times N$ MMI splitters (where N is the number of outputs) have been theoretically and experimentally investigated widely especially for SOI based devices because of their compactness due to high index contrast, low losses, and compatibility with Si electronics and biological samples [11-16]. The highest number of outputs presented theoretically is 64 [17] and experimentally is 12 [13]. This paper reports on the experimental achievement of 20 outputs.

Although MMI splitters are widely used in telecommunication, the devices presented in this paper are developed for biosensors to enable parallel detection and identification of multiple analytes in multiple samples with extremely high sensitivity of detection [18]. This is achieved by connecting a Mach-Zehnder Interferometer (MZI) via S-bends to each output of the MMI splitter. The S-bends are used to



space-out the MZI on the chip. For the device to work as an evanescent field sensor it should be designed to operate in TM polarisation mode to give enhanced sensitivity.

2. Design of a MMI Device

Figure 1 shows the schematic diagram of a 1×2 MMI structure.

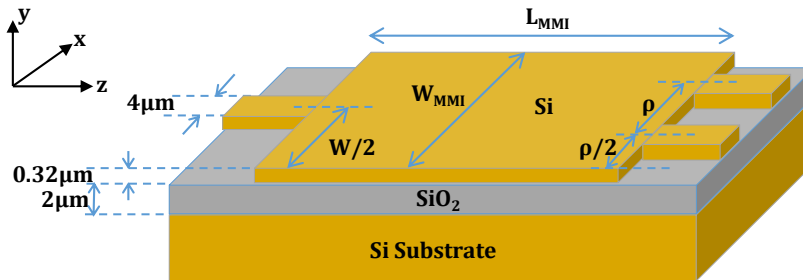


Figure 1: Schematic diagram of a 1×2 MMI structure.

Inside the MMI cavity the beam is split into numerous modes and the symmetric intensity pattern is repeated periodically at the intervals of Λ along the guide:

$$\Lambda = \frac{n_{eff} W_{MMI}^2}{\lambda_0} \quad (1)$$

where n_{eff} and W_{MMI} are the effective refractive index and width of the MMI cavity respectively, and λ_0 is the operating wavelength.

The N images formed are equally spaced across the multimode guide. The distance between the images is known as the Pitch, $\rho = W_{MMI}/N$. In the present work the pitch is fixed at $15 \mu\text{m}$ to prevent interference between the output waveguides. W_{MMI} is determined by the number of output waveguides, N , where $W_{MMI} = N\rho$.

Using these values the approximate MMI length, L_{MMI} is calculated by Equation 2:

$$L_{MMI} = \frac{\Lambda}{N} = \frac{n_{eff} W_{MMI}^2}{N \lambda_0} \quad (2)$$

Equation 2 gives only an approximate length as the modes are not strictly confined to the multimode MMI region [15]. The optimum cavity length is found using a 3D BPM, and attained when the power of all the outputs is equal or almost the same. The MMI device has the lowest insertion loss and highest uniformity at this cavity length.

Figure 2 shows a 1×20 MMI simulated on RSoft Beam Prop. The waveguide width and height are kept at $4 \mu\text{m}$ and $0.32 \mu\text{m}$ respectively in this paper and the operating wavelength is $1.55 \mu\text{m}$.

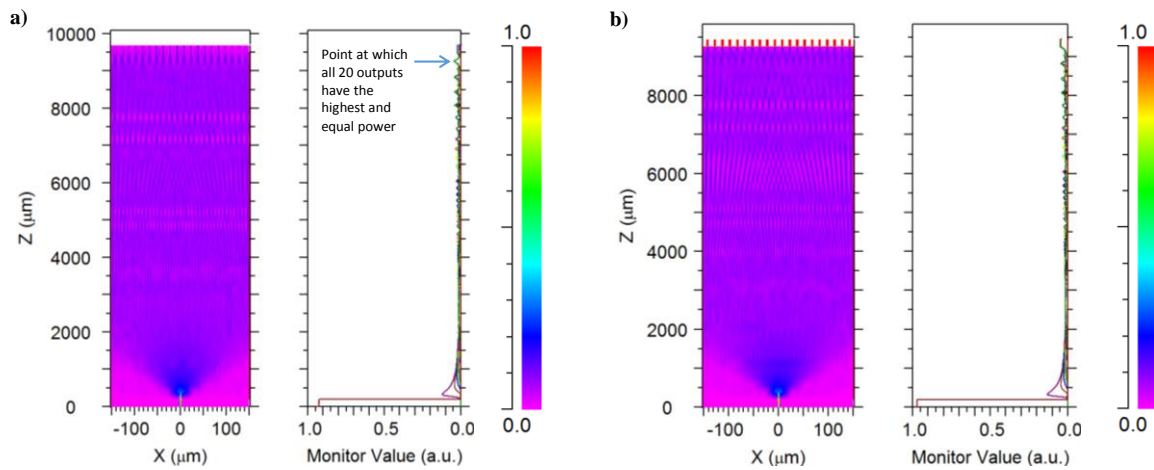


Figure 2: Illustrating TE-like mode simulation for 1x2 MMI with a) longer cavity length and b) optimum cavity length.

3. Simulation Evaluation

3.1. Polarization Dependence

From Table 1 it can be seen that the optimum lengths for the TM-like mode is significantly shorter than for the TE-like mode making the device polarization sensitive. This is an advantage for evanescent field based biosensors which operate in TM-like mode to obtain high sensitivity.

Table 1: Optimum 1xN MMI cavity length for TE-like and TM-like modes.

N	W_{MMI} (μm)	L_{MMI} calculated (μm)	L_{MMI} Optimum (μm)	
			TE-like mode	TM-like mode
2	30	889.7	910.1	802.6
3	45	1334.5	1361.2	1200.4
5	75	2224.3	2269.7	2008.3
8	120	3558.9	3630.4	3205.1
12	180	5338.3	5443.4	4804.2
15	225	6672.9	6803.0	6006.2
20	300	8897.2	9063.5	8012.2

3.2. Insertion Loss and Uniformity

Insertion loss and uniformity are the two most commonly used Figures of Merits to compare the efficiency of MMI devices [19, 20]. Insertion loss is defined as:

$$\text{Loss insertion}(dB) = -10 \log_{10} \left(\sum_{n=1}^N \frac{P_n}{P_{in}} \right) \quad (3)$$

where P_{in} is the input power and P_n is the power of the n^{th} port.

The Non-uniformity is defined as:

$$\text{Non-uniformity(dB)} = -10\log_{10}\left(\frac{P_{\min}}{P_{\max}}\right) \quad (4)$$

where P_{\min} and P_{\max} are the maximum and minimum power observed in the N ports.

Insertion loss and uniformity calculated for MMI splitters up to 1×20 are presented in Table 2.

Table 2: Insertion loss and Non-uniformity for $1 \times N$ MMIs.

N	Insertion Loss (dB)		Non-uniformity (dB)	
	TE-like mode	TM-like mode	TE-like mode	TM-like mode
2	0.11	0.07	0.00	0.00
3	0.12	0.12	0.00	0.00
5	0.16	0.17	0.01	0.01
8	0.19	0.28	0.02	0.01
12	0.21	0.40	0.04	0.03
15	0.23	0.49	0.04	0.03
20	0.23	0.73	0.06	0.08

In theory it is assumed that all guided waves are confined to the MMI cavity whereas in reality there will be leaky modes and radiation modes [4]. Therefore, losses increase as the MMI length increases when N increases [16].

3.3. Optical Bandwidth and Fabrication Tolerance

The wavelength dependence or optical bandwidth is evaluated at the cost of a maximum additional loss of 1dB. Theoretically the optical bandwidth is inversely proportional to the number of outputs [21]. Fabrication tolerance is defined as the $1 \times N$ MMI cavity width (W_{MMI}) variation that produces an additional loss of 1dB. Table 3 shows that the bandwidth reduces as the number of outputs increases, however, the fabrication tolerance stays the same.

Table 3: Bandwidth and Fabrication Tolerance for $1 \times N$ MMIs.

N	Optical Bandwidth (nm)		Fabrication Tolerance (μm)
	TE-like mode	TM-like mode	
2	81	63	± 1
3	60	41	± 1
5	36	26	± 1
8	23	16	± 1
12	15	12	± 1
15	12	9	± 1
20	9	8	± 1

3.4. Wafer Core Thickness Tolerance

The core height of the SOI devices depends on the wafer purchased. The wafer used for this experiment has a standard deviation of 19.8 nm on a silicon core thickness of 320nm and buried oxide of 2 μm . Therefore MMIs were designed to have ± 20 nm of silicon core height tolerance.

Figure 3 shows that the length of the MMI cavity increases linearly as the number of outputs increases; while the number of outputs increases, the tolerance for core thickness decreases.

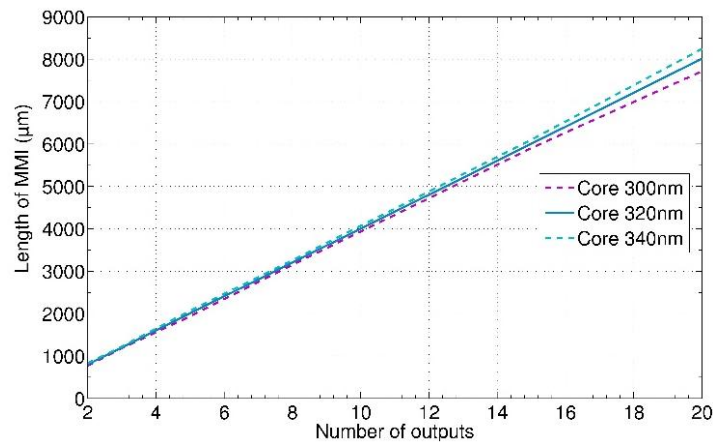


Figure 3: Optimum MMI cavity length for silicon core thickness $0.32\mu\text{m}$ and $\pm 20\text{nm}$ for $1\times N$ MMI.

4. Device Fabrication

A 1×20 MMI was fabricated using photolithography and etch process as schematically illustrated in Figure 4. A commercially available SOI from SOITEC was used with a $0.32\mu\text{m}$ silicon layer on top of $2\mu\text{m}$ buried oxide layer.

The wafer was thoroughly cleaned by sonicating in solvents then dried with Nitrogen and dehydrated at 150°C for 30 minutes. Positive resist AZ6612 was spin coated at 4000rpm for 30 seconds to obtain a $1.2\mu\text{m}$ thick resist layer and soft baked at 110°C for 50 seconds. The resist was then patterned by exposing UV light for 6 seconds at 9mJ/s in a mask aligner (Karl Suss MJB-3). The exposed sample was developed for 30 seconds using AZ726MIF developer, rinsed with water and dried with nitrogen.

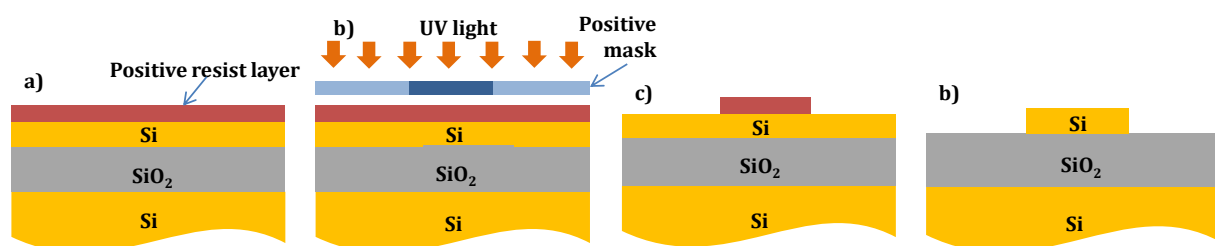


Figure 4: Schematic diagram of photolithography and etch process; a) Spin coating positive resist, b) UV exposure through a mask, c) Developed photoresist patterns and d) Etched silicon patterns.

The silicon was etched for 110 seconds by inductively coupled plasma (ICP) etching using CORIAL 200L plasma etcher and the resist was removed with oxygen plasma for 105 seconds. In both processes the etching time included an extra 20 seconds to compensate for different etch rates at different point of the sample. This may result in etching in to the oxide layer slightly, but this will not affect the function of the product. Figure 5 shows the microscopic image of the outputs of an etched MMI.

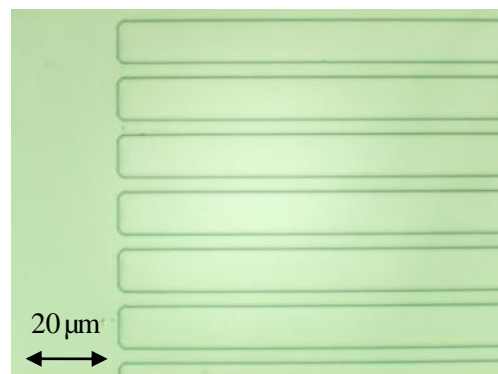


Figure 5: Etched Si patterns of a 1×20 MMI coupler output waveguides(View from microscope x100).

Since the input waveguide has a cross section of $4\mu\text{m}$ by $0.32\mu\text{m}$ the coupling loss from an input tapered fibre to the Si waveguide would be high. To minimise the coupling loss, and more effectively couple light into the waveguide and out, a tapered SU-8 structure is used. SU-8 is an epoxy-based negative photoresist that contains eight epoxy groups per molecule giving the polymer very high functionality. Regions exposed to UV light polymerise resulting in an extremely high crosslink density [22] and a high degree of thermal stability. SU-8 has been used as optical waveguide in biosensing applications as it provides good transmission properties and low propagation loss [23-25]. The tapered SU-8 structure is $2\mu\text{m}$ in height and a width that tapers from $10\mu\text{m}$ to $4\mu\text{m}$.

The SU-8 photolithography process as schematically illustrated in figure 6 was altered slightly from the standard protocol to prevent crack formation and poor adhesion between the resist and silicon.

1ml of resist per 25ml of substrate diameter was dispensed on to the surface of the etched sample. To obtain $2\mu\text{m}$ thick layer the SU-8 was spread at 500rpm for 5 seconds and Spin coated at 2000rpm for 30 seconds as shown in Figure. The sample was then soft baked at $65\text{ }^\circ\text{C}$ for 15 minutes and $95\text{ }^\circ\text{C}$ for 1 minute on two different hotplates. The sample needs to be gradually heated and cooled to room temperature to reduce thermal shock which causes the formation of waves on the surface of the resist. Leaving the sample overnight at room temperature helps drive out solvents and reduces the tackiness.

The resist was then exposed to UV light for 6 seconds at 9mJ/s as shown in figure. A post exposure bake was then done in a hotplate where the temperature was gradually increased from $65\text{ }^\circ\text{C}$ to $95\text{ }^\circ\text{C}$ during a time span of 20 minutes. The exposed resist cross links and harden during the post exposure bake. The temperature of the hotplate was gradually ramped down to $40\text{ }^\circ\text{C}$ and then the sample was removed from the hotplate and allowed to cool to room temperature.

Once the sample was cooled down it was developed with EC solvent for 40 seconds and then washed with Isopropanol and dried with Nitrogen to obtain tapered structures as shown in Figure 7.

To make the SU-8 mechanically and thermally stable a hard bake was incorporated into the process. The sample was hard baked in an oven where the temperature was gradually ramped up from $65\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$ during a 35 minute time period and then allowed to cool naturally at room temperature.

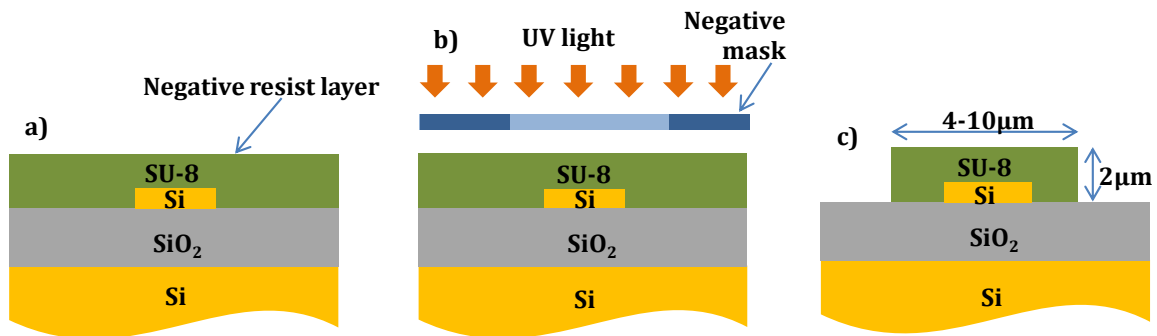


Figure 6: Schematic diagram of SU-8 photolithography process a) 2 μm thick SU-8 resist later spin coated, b) UV exposure over negative mask and c) Final structure with SU-8 on Si.

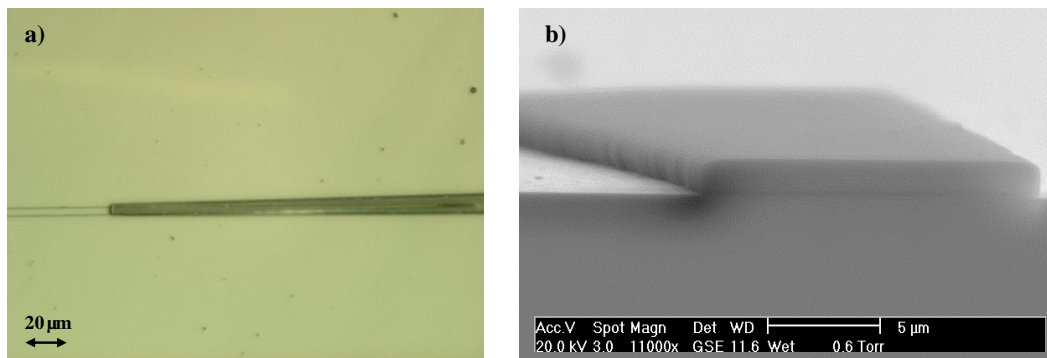


Figure 7: a) SU-8 taper well aligned with the waveguide (view from microscope x20) and b) Wafer cleaved through the SU-8 (view from ESEM).

After fabrication the samples were cleaved perpendicular to the SU-8 tapers to obtain good quality end facets. A smooth facet is needed to minimise light scatter and maximise coupling efficiency. First a layer of positive resist was spin coated and soft baked for 30 seconds at 110 °C in order to protect the device features. Two lines were scribed on either side of the tapered waveguide on a manual diamond scribe and then placed on a rubber mat with the sample features facing down. A small pressure was applied with a pen just enough to crack the wafer. Figure 7 b shows an ESEM image of a wafer cleaved smoothly through the SU-8.

5. Experimental Characterisation Results

An optical bench set up was used as shown in figure 8 to evaluate the 1×20 MMI. A tuneable laser (Agilent 8164B Lightwave measurement system from 1465 μm-1575 μm) and a red diode was connected to a tapered fibre with a spot diameter of 2.5 μm was used to couple light into the input SU-8 tapered waveguide of the MMI. A power meter was used to measure the light intensity of the light in front of the camera.

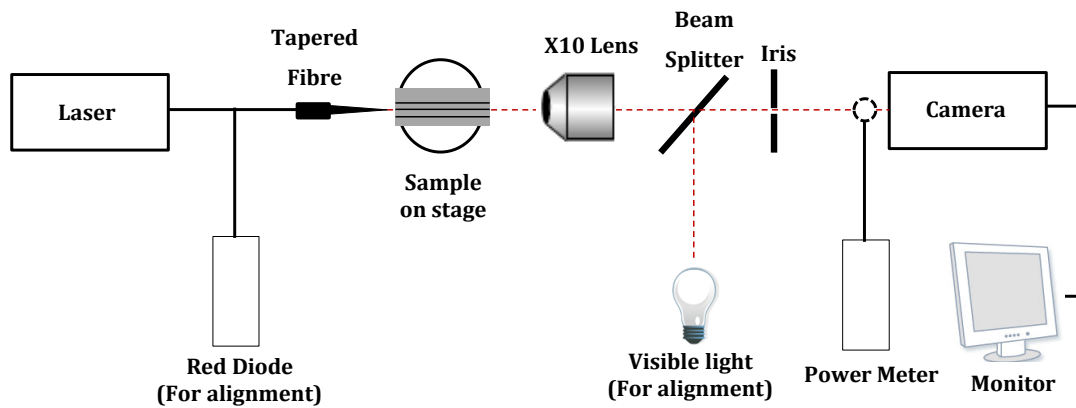


Figure 8: Schematic representation of Optical Bench set-up.

Figure 9 shows the successful operation of a 1×20 MMI splitter as seen from the infrared camera. It can be seen that the outputs are multimoded as expected.

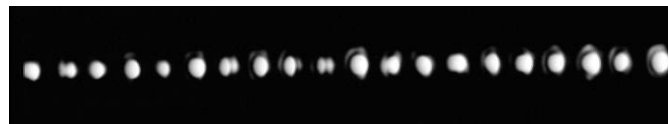


Figure 9: Outputs of a 1×20 MMI splitter.

6. Conclusion

A 1×20 MMI splitter has been designed, fabricated and tested in the lab. This device can be further improved by reducing the silicon core thickness from $0.32 \mu\text{m}$ to $0.22 \mu\text{m}$ which will greatly reduce the footprint of the MMI and will be more suitable for standard SOI fabrication. By using narrow single mode input and output waveguides and connecting N individual Mach-Zehnder interferometers to the outputs, this device can be used for evanescent field biosensing applications [18, 26].

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